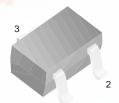


FJX4010R

Switching Application (Bias Resistor Built In)

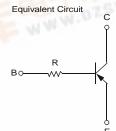
- Switching circuit, Inverter, Interface circuit, Driver Circuit WWW.DZSG.COM
- Built in bias Resistor (R=10KΩ)
- Complement to FJX3010R



SOT-323

1. Base 2. Emitter 3. Collector





PNP Epitaxial Silicon Transistor

Absolute Maximum Ratings Ta=25°C unless otherwise noted

| Symbol | Parameter | Value | Units |
|------------------|-----------------------------|-----------|-------|
| V _{CBO} | Collector-Base Voltage | -40 | V |
| V_{CEO} | Collector-Emitter Voltage | -40 | V |
| V _{EBO} | Emitter-Base Voltage | -5 | V |
| l _C | Collector Current | -100 | mA |
| Pc | Collector Power Dissipation | 200 | mW |
| TJ | Junction Temperature | 150 | °C |
| T _{STG} | Storage Temperature | -55 ~ 150 | °C |

Electrical Characteristics T_a=25°C unless otherwise noted

| Symbol | Parameter | Test Condition | Min. | Тур. | Max. | Units |
|-----------------------|--------------------------------------|---|------|------|------|-------|
| BV _{CBO} | Collector-Base Breakdown Voltage | $I_C = -100 \mu A, I_E = 0$ | -40 | | | V |
| BV _{CEO} | Collector-Emitter Breakdown Voltage | I_E = -1mA, I_B =0 | -40 | -12 | - TV | V |
| I _{CBO} | Collector Cut-off Current | V _{CB} = -30V, I _E =0 | | E. | -0.1 | μΑ |
| h _{FE} | DC Current Gain | V_{CE} = -5V, I_{C} = -1mA | 100 | W.M. | 600 | |
| V _{CE} (sat) | Collector-Emitter Saturation Voltage | $I_C = -10 \text{mA}, I_B = -1 \text{mA}$ | | | -0.3 | V |
| C _{ob} | Output Capacitance | $V_{CB} = -10V, I_{E} = 0$ f=1MHz | | 5.5 | | pF |
| f _T | Current Gain Bandwidth Product | V _{CE} = -10V, I _C = -5mA | | 200 | | MHz |
| R | Input Resistor | | 7 | 10 | 13 | ΚΩ |

Typical Characteristics

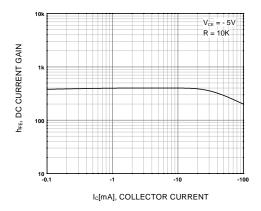


Figure 1. DC current Gain

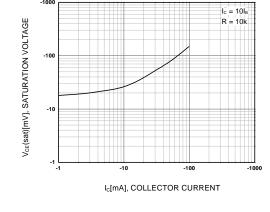


Figure 2. Collector-Emitter Saturation

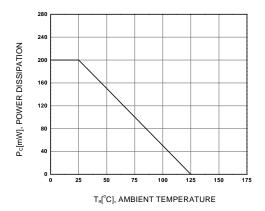
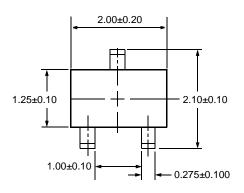


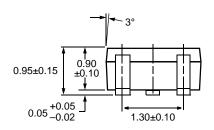
Figure 3. Power Derating

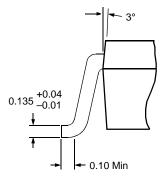
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Package Dimensions

SOT-323







Dimensions in Millimeters

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| CoolFET™ | FASTr™ | MicroFET™ | PowerTrench [®] | SuperSOT™-6 |
| CROSSVOLT™ | FRFET™ | MicroPak™ | QFET™ | SuperSOT™-8 |
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| EcoSPARK™ | GTO™ | MSX™ | QT Optoelectronics™ | TinyLogic™ |
| E ² CMOS™ | HiSeC™ | MSXPro™ | Quiet Series™ | TruTranslation™ |
| EnSigna™ | I^2C^{TM} | OCX^{TM} | RapidConfigure™ | UHC™ |
| Across the board. | . Around the world.™ | OCXPro™ | RapidConnect™ | UltraFET [®] |
| The Power Franc | hise™ | OPTOLOGIC [®] | SILENT SWITCHER® | VCX^{TM} |
| Programmable Ad | ctive Droop™ | OPTOPLANAR™ | SMART START™ | |

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